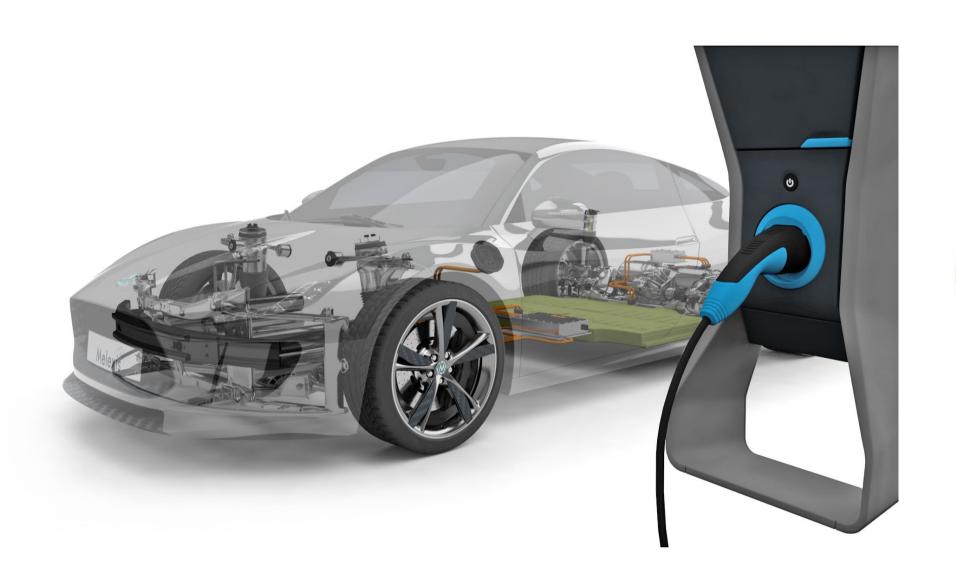
# Booth sessions







# Melexis analyst day 2018

BMW Brand Store - Boulevard de Waterloo 23, 24 Waterloolaan - 1000 Brussels





**Bruno Boury** Product Line Manager BU: Sense & Drive PL: Current Sensors

# **CURRENT SENSORS PRODUCT PORTFOLIO**



(OBC = on-board charger)

**ACDC** inverter

Safety

**Battery** 

(12V, 48V, HV)

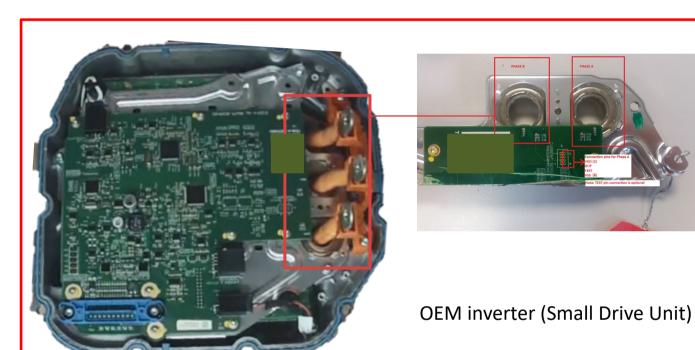
**DCAC** inverter

(eAxle, 48V BSG, ...)

2005

- MLX91216/17 pushing the thermal stability limits further

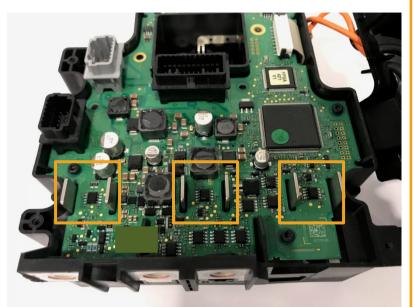
- MLX91210 opens new Plug&Power™ portfolio
- MLX91208 Very High Field for traction Inverters
- MLX91208 High Speed Portfolio (Low & High Field)
- MLX91209 introducing patented lifetime stability
- MLX91206/07 programmable ASSP for Inverter
- MLX91206/07 programmable ASSP for Battery/DCDC
- ASICs for industry & automotive
- MLX91205 IMC-Hall® technology for industrial applications









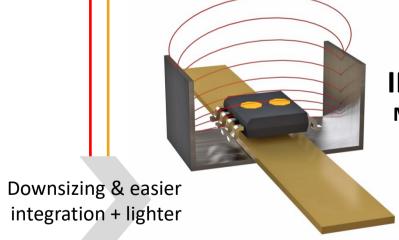


**OEM EV Inverter** 





Battery Monitoring 12V / HV Junction Box



IMC-Hall® **MAX >1.2kA** 



Plug&Power™ **MAX 50A** 

Ultimate Integration: CMOS + primary + isolation + stray field immunity in standard footprint



# **Conclusion**

Incumbent position at renowned TIER2 & TIER1

**DCDC** converter

Plug&Power™ new portfolio addressing new applications (module power 3 monitoring, OBC, HV DCDC converters)

# Fit for adjacent markets

- Industry electric motor control (automation) and automotive traction motor control have very similar requirements  $\rightarrow$  single product development amortization
- Solar market is volatile, but under permanent growth in the green energy mix
- Plug & Power portfolio is ultimate integration for <50A

# **Broad Hall effect sensor portfolio**

- 2nd Generation on the market (being) designed in at nearly all OEMs
- Proprietary IMC-Hall® technology brings advantages for designers
- New product range Plug&Power™ unlocking new markets (OBC, HV-DCDC...)
- Market leading sensor accuracy (thermal & lifetime)

# INTERIOR/EXTERIOR LED LIGHTING CONTROLLER ICs







- LIN RGB Gen 2 - LIN-to-LIN Gateway - Dual LIN RGB

2016 - LIN RGB Gen 1





2018

2007

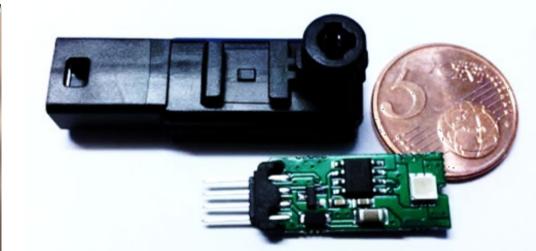
- Worlds' 1st fully integrated LIN IC

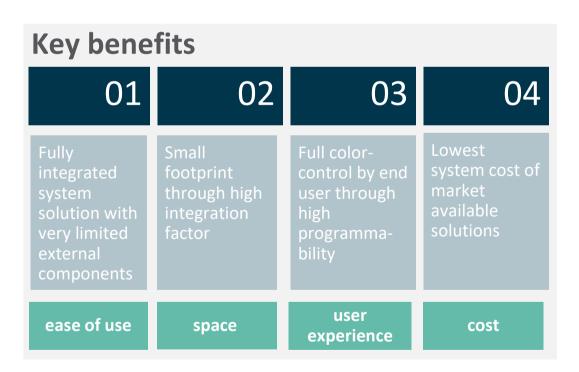






























# **Broad and growing product portfolio**

- Melexis is #1 worldwide for RGB ambient light controller ICs
- Successful re-use of system on chip integration since Gen 1
- Easy development of new family members
- Leading integration by using best in class SOI technology

# **Target applications**

- Automotive RGB ambient lighting
- Animated RGB ambient lighting
- Surface integrated lighting
- Automotive exterior lighting

onclusion		
1	Full programmability through integrated Flash based microcontroller	
2	Strong focus on user experience usable for all types of v (including electric)	
3	Broad fit for automotive interior and exterior lighting applications for all OEMs	

Integrated system solutions to overcome LIN-bus limitations





Nick Czarnecki Product Line Manager BU: Sense & Drive PL: Magnetic Position Sensors

# MAGNETIC POSITION SENSORS PRODUCT PORTFOLIO



CBS

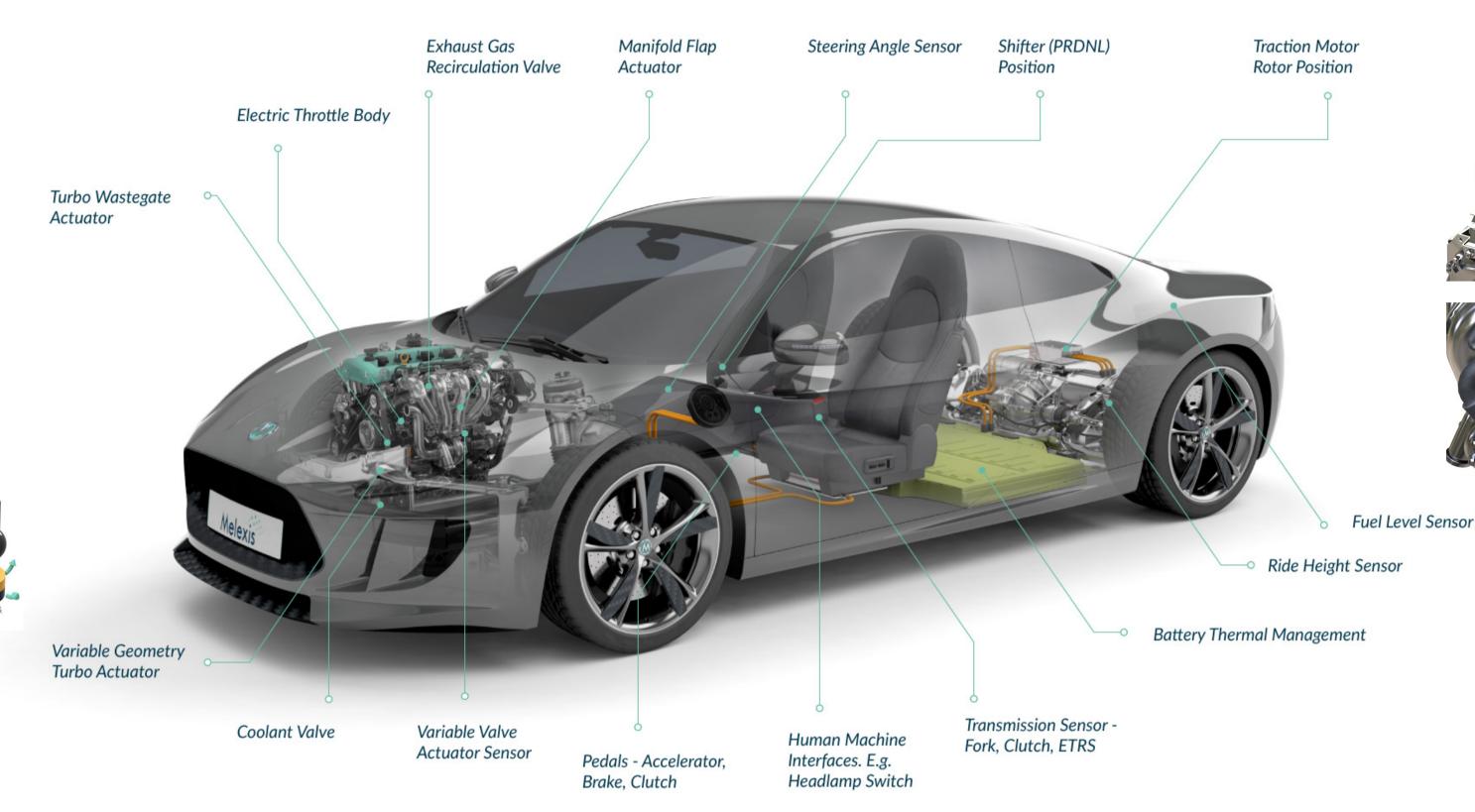


## **Second Gen inductive ASIC** 2018 First ASIL-C magnetic angle sensor Stray field robust angular sensor 2017 - 500 Millionth Triaxis Sensor Sold 2015 - Triaxis magnetic node for consumer - Linear hall with functional safety and 2014 multipoint temperature calibration - 100 Millionth Triaxis Sensor Sold - PCB-less package launched 2012 - 100 Millionth Linear Hall Sensor Sold - First linear hall with magnet temp compensation 2011 - High speed SPI angular sensor 2010 - First inductive ASIC - SENT 2007 support integrated 2009 - First 3D linear and joystick magnetic position sensor \_\_ 2007

- First rotary magnetic position sensor

- First programmable linear hall

- First programmable linear hall with EEPROM



# Conclusion

3

- Best in class performance angle sensors for nearly every current and future automotive position sensing application
  - - Focused on the future to support electrification, autonomous driving, and adjacent market trends and requirements

# Fit for adjacent markets

- Low power versions allow for battery operation enabling internet connected, always-on sensing
- Flexible nature (3D sensing) removes design constraints in placement of the magnet and sensor

# Broad position sensor portfolio

- Unique packaging options (PCB, PCB-less) enable meeting customer size, shape and weight requirements from large trucks to small personal transports
- Functional safety (ASIL) capability enables integration into safety-conscious applications like autonomous vehicles
- Creation of stray field robust magnetic allows for growing together with the increasing number of electrified vehicles

2004

2003

2000

2020

2014

2008

**Marc Lambrechts** 

# EMBEDDED MOTOR DRIVER ICs PORTFOLIO



CBS

Safety

AFS headlight

Grille shutter

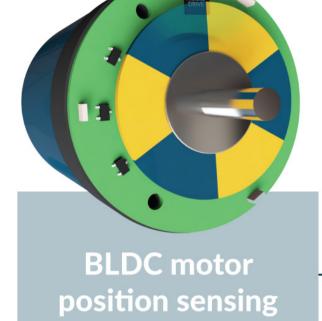
<10W

<100W

**Smart Valve** 



Small waterpump



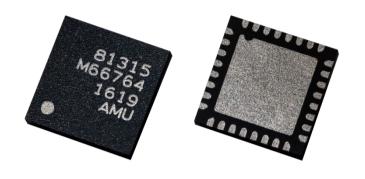
System controller

Drive

eg. MLX81315

**Output shaft** position sensing

- Gen3 smart lin drivers, single-die (0.5A..1A..10a..100A)



- Gen2 smart lin drivers, single-die (0.5A..1A..10A)

- Gen1 smart lin driver, dual-die <0.5A



>100W

**HVAC** flap



Pumps



Engine Cooling Fan

>100W

3-phase fan



Window Lift, Sunroof

# Unique areas of expertise

- Enable motor drive with lowest heating and lowest acoustic noise
- Enable low cost, small size mechatronics with digital interface
- Sense & Drive concept, integration of motor driver and sensors
- World-class hw+sw solution support by our application engineers

# **Broad motor driver IC portfolio**

- Smart embedded drivers for 1W...1 KW
- Supporting all motor types BLDC, DC, Steppers
- ECU communication via LIN / PWM interface
- Melexis IP for silent sensorless motor drive

# Conclusion Enabling smart & small, plug & play mechatronics World class technology: smallest single die, high temperature Flash memory, robust LIN cell, reliable motor sensing

Laurent Otte

# PRESSURE SENSORS SOLUTIONS PRODUCT PORTFOLIO



Safety

GEN 1 GEN 2 GEN 3 2018

2009

2007

1993

- Packaged Absolute Pressure Sensor Solution on PCB

2013 - Packaged Relative Pressure Sensor Solution on PCB

- Bare die discrete MEMS Automotive

- Bare die monolithic MEMS Automotive





- Bare die discrete MEMS Medical





# Fit for adjacent markets

- Primary focus on automotive powertrain for ICEs and hybrid vehicles
- Same devices can be used for in -cabin comfort applications
- Same devices can be used for white good applications



# **Broad pressure sensor portfolio**

- Absolute Pressure
- Mid Pressure
- Sensor Interfaces ASSPs



# Conclusion

Full solutions including MEMS, sensor interface, package & calibration

Unmatched performance and robustness

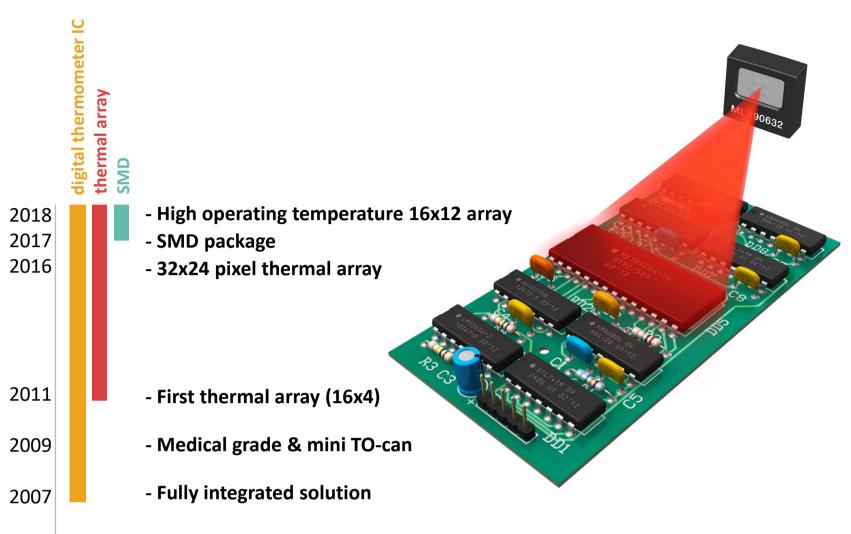


# TEMPERATURE SENSORS PRODUCT PORTFOLIO



CBS Safety







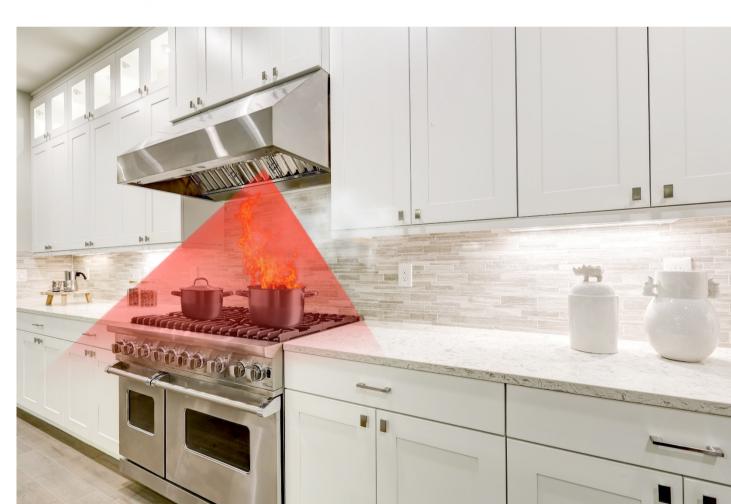
- Discrete analog sensor 2000

2003









# Single pixel temperature sensing

- Digital & factory calibrated, easy to use
- Broad temperature range & medical grade
- Miniaturization & SMD: high performance & small size

# Thermal array portfolio

- Unique price vs. resolution vs. performance point
- People detection, counting and location for smart building
- Safety applications (overheating prevention)





# Conclusion

1	World class performance & innovation since 2000
2	Strong focus on adjacent markets with broad application portfolio
3	Cost efficient thermography and miniaturization enable new applications and markets



Gaetan Koers
Product Line Manager
BU: Sense & Light
PL: Optical Sensors

# TIME-OF-FLIGHT SENSORS PRODUCT PORTFOLIO

CBS Body
Safety



- Gen 2 QVGA ToF chipset

- Gen 1 QVGA ToF chipset

2014 - Gen 1 QVGA ToF sensor

2017



VGA: 640 x 480 px

# Fit for adjacent markets

QVGA: 320 x 240 px

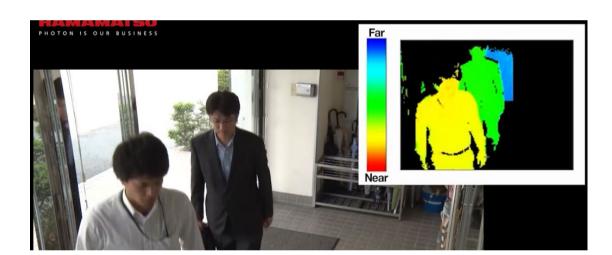
• Same IC designed for automotive, applicable also for adjacent markets (robot navigation, security, ...)











# **Broad TOF sensor portfolio**

- Gen2 as cost-effective QVGA solution
- Gen3 with VGA resolution for wide field-of-view sensing, comfort & safety
- Focus on automotive

# Leadership in automotive-grade Time-of-Flight sensors Widest product portfolio, with QVGA and VGA resolution Designed for automotive. Applied to in-cabin sensing, exterior sensing, robot vision and more.





**Dieter Verstreken**Product Line Manager
BU: Sense & Drive
PL: Latch & Switch

# LATCH & SWITCH PRODUCT PORTFOLIO



BS Body

# **V**





2015

2014

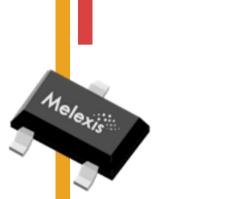
2013

2012

2018 - Lateral sensing
2017 - Dual die
2016 - Expand lateral s

- Expand lateral sensing with Triaxis® on Gen2

- ASIL B design Micropower Introducing Triaxis® technology
- ASIL A design Integrated capacitor (pcb-less)
- Customer programmable 3-wire
- First 2-wire sensor with EEPROM

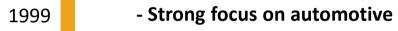






















- Same IC designed for automotive, re-used for adjacent markets (industrial, white goods, 2-wheelers).
- Ideal fit for drive applications with Melexis actuator chipset

# Broad hall effect sensor portfolio

- Successful re-use of platform & generation concepts since 1993
- 2 billion sensors in the field
- High rate of new product launches thanks to platform concept
- Clear USPs (low power) ensuring growth and enabling customized ASSPs

# Conclusion

	World class performance and broad application	coverage
1	since 1993	

- Strong focus on electrification, safety & product customization
- Broad market fit, technologies designed for automotive, easily re-valued in adjacent markets (white goods, 2-wheelers)



# Acronym list

Poster	Acronym	Description
Current	CMOS	Complementary Metal-Oxide Semiconductor
	TIER1	A tier one company is the most important member of a supply chain, supplying components directly to the original equipment manufacturer (OEM) that set up the chain.
	IMC	Integrated Magneto Concentrator
	OBC	On Board Charger
	HV	High Voltage
	ADAS	Advanced Driver Assistance Systems
	DCDC	Direct Current to Direct Current
	EV	Electric vehicle
	OEM	Original Equipment Manufacturer
Opto	TOF	Time-of-Flight
	VGA	Video Graphics Array
	QVGA	Quarter Video Graphics Array
	IC	Integrated Circuit
LIN RGB	LIN	Local Interconnect Network
	RGB	Red, Green and Blue
	SOI	Silicon On Insulator
Embedded motors	B-EMF	Back Electromotive Force
	UVW	3 terminal pins of BLDC motor
	BLDC	Brushless DC
	DC	Direct Current
	ECU	Engine Control Unit
	PWM	Pulse Width Modulation
	IP	Intellectual Property
	AFS	Adaptive Front-Lighting System
	HVAC	Heating, Ventilation, and Air Conditioning
	HW	Hardware
	SW	Software
L&S	TSOT	Thin Small Outline Transistor
	EEPROM	Electrically Erasable Programmable Read Only Memory
	ASIL	Automotive Safety Integrity Level defined in ISO 26262 standard
	PCB	Printed Circuit Board
Temperature	SMD	Surface Mount Device
	RF	Radio Frequency
Pressure	MEMS	Micro-Electro-Mechanical Systems
	ASSP	Application Specific Standard Product
	ICE	Internal Combustion Engine
Position	SENT	Single Edge Nibble Transmission
	SPI	Serial Peripheral Interface. A communications protocol for use between two integrated circuits
	I2C	Inter-Integrated Circuit. A communications protocol for use between two integrated circuits
	DMP-4	Dual Mold Package, 4 pins
	PRDNL	Park, Reverse, Neutral, Drive, Low (automatic transmission positions)
	ETRS	Electronic Transmission Range Selection
	EMC	Electromagnetic Compatability
	G	Gauss, Unit of magnetic field
	mT	millitesla, Unit of magnetic field

